

## 7900 Uno (Model 7910)

## Automatic, Single-Spindle Dicing System

### Configuration

- Spindle: 2"
- Size: 8"

#### **Features & Benefits**

- Single spindle
- Low cost-of-ownership
- Small footprint and compact (short height)
- High reliability
- Easy to use, intuitive, touch screen based GUI
- Easy to maintain
- High accuracy (enhanced by advanced error mapping correction)
- Advanced vision automation
- Comprehensive, optimized dicing cycle
- Yield enhancement and cost saving capabilities
- Kerf inspection and quality analysis
- Blade wear monitoring and projection
- Spindle load monitoring
- Process data logging and statistical analysis

#### **Optional Capabilities**

- Advanced continuous magnification vision system
- Broken blade detector
- Integrated dressing station
- Variety of porous ceramic chucks (4",5", 6" and 8")
- High power spindle
- Bar code reader
- Dicing Floor Management system (DFM)

#### **Leading Applications**

- LED packages and wafers
- Silicon wafers / Discrete devices
- Power device wafers
- Glass wafers

#### The Ultimate Dicer for

- Universities and research institutes
- IC back-end plants (for 2"-8" wafer dicing production lines)
- LED beginners (for process development, pilot production, R&D)
- MEC Micro Electronic Components

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### **Specifications**

Workpiece Size	8"
Spindle	60,000 rpm / 1.2 KW
Blade Size	2"
Y Axis	
Drive	Ball bearing lead screw
Control	Linear encoder
Resolution	0.2 µm
Cumulative Accuracy	1.5 µm
ndexing Accuracy	1.0 µm
Cutting Range	200 mm
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X Axis	Air slide
Drive	Ball bearing lead screw
Feed Rate	Up to 600 mm/sec
Cutting Range	410 mm
Z Axis	
Drive	Ball bearing lead screw
Control	
	Rotary encoder
Resolution	0.2 μm
Repeatability	1.0 µm
Stroke	30 mm
Zi Axis	
Drive	Closed-loop, Direct-drive
Control	Linear encoder
Repeatability	4 arc-sec
Stroke	350°
Vision System	Digital camera, High bright LED illumination (vertical and oblique)
	Continuous digital magnification from X70 to X280 or, from X35 to X140 (optional
Standard Features	Automatic alignment, Automatic kerf insprction, Automatic Y offset correction
User Interface	Flat 17" touch screen, Intuitive GUI (Graphic User Interface),
	Multilanguage support, Keyboard & Mouse (optional)
Optional	BBD (Broken Blade Detector), Barcode reader, High power spindle (2.4 KW)
	Dress station, DFM (Dicing Floor Management)
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Utilities	000 040 140 50 1011
Electrical	200-240 VAC, 50/60 Hz, single phase
Air	260 L/min @ 5.5 bar
Spindle Coolant	1.1 L/min
Cutting Water	Up to 3 L/min
Dimensions	
WxDxH	875 x 975 x 1450 mm
Weight	830 Kg
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invironmental	
[emperature	Typical room temperature: 20 °C - 25 °C
Humidity	< 70% (relative, non-condensing)
Floor	Floor must be vibration free

Note: Specifications are subject to change without notice.





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